

# SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIER

# GBJ15005 THRU GBJ1510

VOLTAGE RANGE CURRENT

**50 to 1000 Volts 15.0 Ampere** 

#### **FEATURES**

 Plastic package has UL flammability Classification 94V – 0

• Glass passivated chip junction

High case dielectric strength of 1500 V<sub>RMS</sub>

High surge current capability

• High temperature soldering guaranteed: 260 °C /10 seconds, 0.375" (9.5mm) lead length

### MECHANICAL DATA

Case: Molded plastic body

• Terminals: Plated leads solderable per MIL-STD-750

method 2026

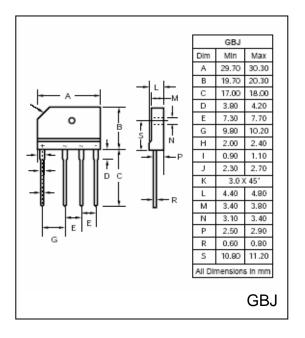
Mounting position: any (Note 2)
Mounting Torque: 6 in-lbs max.
Weight: 0.26 ounce, 7.4 gram

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

• Single Phase, half wave, 60Hz, resistive or inductive load

For capacitive load derate current by 20%



	SYMBOLS	GBJ 15005	GBJ 1501	GBJ 1502	GBJ 1504	GBJ 1506	GBJ 1508	GBJ 1510	UNIT
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current, At $T_C = 100^{\circ}$ C	I <sub>(AV)</sub>	15							Amps
Peak Forward Surge Current									
8.3mS single half sine wave superimposed on	$I_{FSM}$	240							Amps
rated load (JEDEC method)									
Rating for Fusing (t<8.3mS)	$I^2t$	240						$A^2s$	
Maximum Instantaneous Forward Voltage drop per Bridge element 7.5A	$V_{\rm F}$	1.05						Volts	
Maximum DC Reverse Current at Rated $T_A = 25$ °C	T	10							μА
DC Blocking Voltage per element $T_A = 125$ °C	$I_R$	500							
Typical Junction Capacitance, per leg (Measured at 1.0MHz and applied reverse voltage of 4.0V)	$C_{\mathrm{J}}$	60							pF
Typical Thermal Resistance (Note 1 and 2)	$R_{\theta JA}$	2.7						<sup>o</sup> C/W	
Operating Junction Temperature Range	$T_{J}$	(-65 to +150)							<sup>o</sup> C
Storage Temperature Range	$T_{STG}$	(-65 to +150)							<sup>o</sup> C

#### **Notes:**

- 1. Thermal resistance from junction to case per element. Unit mounted on 300mm x 300mm x 1mm) aluminum plate heat sink.
- 2. Recommended mounting position is to bolt down on heatsink with silicon thermal compound for maximum heat transfer with #6 screw

## RATINGS AND CHARACTERISTIC CURVES GBJ15005 THRU GBJ1510

Instantaneous Reverse Current (µA)

